

Supplemental Application Data Sheet

Application Information

Application number::	10/702,235
Filing Date::	11/05/03
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R??::	
Number of CD disks::	
Number of copies of CDs::	
Sequence Submission::	
Computer Readable Form (CRF)?::	
Number of copies of CRF::	
Title::	Fabrication Method For Electronic System Modules
Attorney Docket Number::	000939-119030US
Request for Early Publication::	No
Request for Non-Publication::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	19
Small Entity?::	[[Yes]] <u>No</u>
Latin name::	
Variety denomination name::	
Petition included?::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers One::	
Secrecy Order in Parent Appl.::	No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Peter
Middle Name:: C.
Family Name:: Salmon
Name Suffix::
City of Residence:: Mountain View
State or Province of Residence:: CA
Country of Residence:: US
Street of Mailing Address:: 200 E. Dana Street, # 8
City of Mailing Address:: Mountain View
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 94041

Correspondence Information

Correspondence Customer Number:: 20350

Representative Information

Representative Customer Number:: 20350

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application 10/237,640	Continuation-in-part of An Appln. claiming benefit under 35 USC 119(e) of	10/237,640 60/318,271	09/06/02 09/07/01

Assignee Information

Assignee Name:: Hynix Semiconductor, Inc.
Street of mailing address:: Daechi tower 891
Second line of mailing address:: Daechi-Dong, Kangnam-Gu
City of mailing address:: Seoul
State or Province of mailing address::
Country of mailing address:: Republic of Korea
Postal or Zip Code of mailing address::